

为 您 的 产 品 保 驾 护 航

PRODUCT DATASHEET

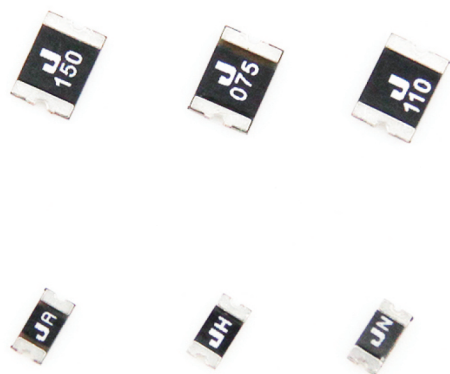
Surface Mount PTC Devices

ASMD2018 Series Surface Mount PTC Devices

Description

The ASMD2018 series provides surface mount resettable overcurrent protection with holding current from 0.3A to 3.5A.

This series is suitable for applications with higher holding current and higher working voltage up to 60V.



Features

- RoHS compliant and lead-free
- Low profile
- Halogen-free
- High voltage
- Symmetrical design
- Fast response to fault current
- compact design saves board space
- Compatible with high temperature solders

Agency Approvals

Regulation	Standard
 RoHS	2002/95/EC
 Halogen Free	EN14582

Applications

- Industrial control
- Security systems
- PDAs / digital cameras
- Game console port protection
- Power over Ethernet (POE)
- IEEE 1394 port protection
- HDMI 1.4 Source protection
- Powered USB for POS and IPC
- Low voltage telecom equipment
- USB port protection - USB 2.0, 3.0&OTG
- PC motherboards-plug and play protection
- Automotive electronics control module protection

Performance Specification

Model	V _{max} (V dc)	I _{max} (A)	I _{hold} @25°C (A)	I _{trip} @25°C (A)	P _d Typ. (W)	Maximum Time To Trip		Resistance	
						Current (A)	Time (Sec)	R _{i min} (Ω)	R _{1max} (Ω)
ASMD2018-030-60V	60	40	0.30	0.6	1.4	1.5	3.0	0.50	2.30
ASMD2018-050-60V	60	40	0.50	1.0	1.4	2.5	5.0	0.20	1.00
ASMD2018-075-60V	60	40	0.75	1.5	1.4	8.0	0.5	0.11	0.63
ASMD2018-100-15V	15	40	1.00	2.0	1.4	8.0	0.5	0.06	0.36
ASMD2018-100-33V	33	40	1.00	2.0	1.4	8.0	0.5	0.06	0.36
ASMD2018-150-15V	15	40	1.50	3.0	1.4	8.0	1.0	0.05	0.17
ASMD2018-150-33V	33	40	1.50	3.0	1.4	8.0	1.0	0.05	0.17
ASMD2018-200-6V	6	40	2.00	4.0	1.4	8.0	3.0	0.03	0.10
ASMD2018-200-10V	10	40	2.00	4.0	1.4	8.0	3.0	0.03	0.10
ASMD2018-200-12V	12	40	2.00	4.0	1.4	8.0	3.0	0.03	0.10
ASMD2018-200-16V	16	40	2.00	4.0	1.4	8.0	3.0	0.03	0.10
ASMD2018-200-24V	24	40	2.00	4.0	1.4	8.0	3.0	0.03	0.10
ASMD2018-260-24V	24	40	2.60	5.2	1.6	8.0	5.0	0.02	0.075
ASMD2018-300-16V	16	40	3.00	6.0	1.6	8.0	10.0	0.015	0.050
ASMD2018-350-12V	12	40	3.50	7.0	1.6	8.0	10.0	0.010	0.040
ASMD2018-500-6V	6	40	5.00	10.0	1.6	10.0	4.0	0.006	0.03
ASMD2018-500-12V	12	40	5.00	10.0	1.6	10.0	4.0	0.006	0.03

I_{hold} = Hold Current. Maximum current device will not trip in 25°C still air.

I_{trip} = Trip Current. Minimum current at which the device will always trip in 25°C still air.

V_{max} = Maximum operating voltage device can withstand without damage at rated current (I_{max}).

I_{max} = Maximum fault current device can withstand without damage at rated voltage (V_{max}).

P_d = Power dissipation when device is in the tripped state in 25°C still air environment at rated voltage.

R_{i min/max} = Minimum/Maximum device resistance prior to tripping at 25°C.

R_{1max} = Maximum device resistance is measured one hour post reflow.

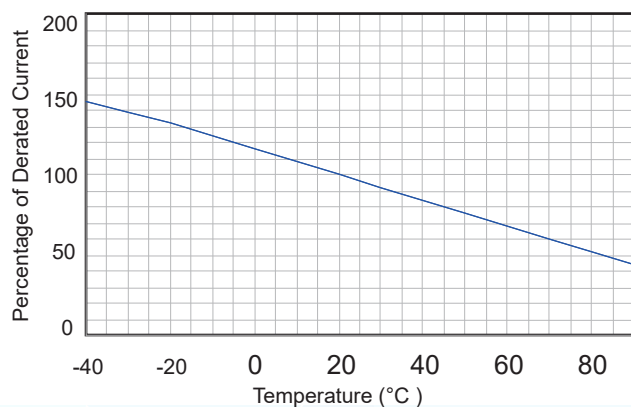
CAUTION : Operation beyond the specified ratings may result in damage and possible arcing and flame.

Environmental Specifications

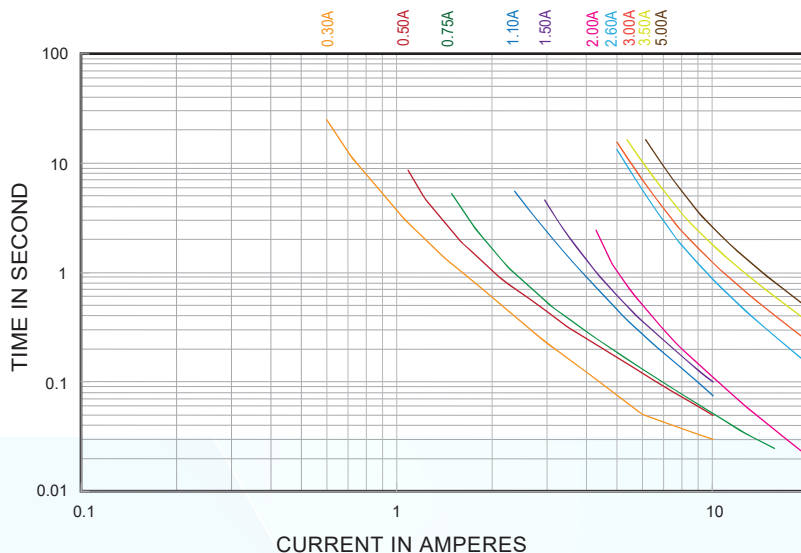
Test	Conditions	Resistance change
Passive Aging	+85°C, 1000 hrs.	±5% typical
Humidity Aging	+85°C, 85% R.H. , 168 hours	±5% typical
Thermal Shock	+85°C to -40°C, 20 times	±33% typical
Solvent Resistance	MIL-STD-202,Method 215	No change
Vibration	MIL-STD-202,Method 201	No change
Moisture Sensivity Level	Level 1, J—STD—020	
Storage Conditions	+40 °C Max. 70% RH Max. Packed in original packaging.	
Operating Temperature : - 40 °C to +85 °C		
Maximum Device Surface Temperature in Tripped State:125 °C		

Environmental Characteristic

Thermal Derating Curve



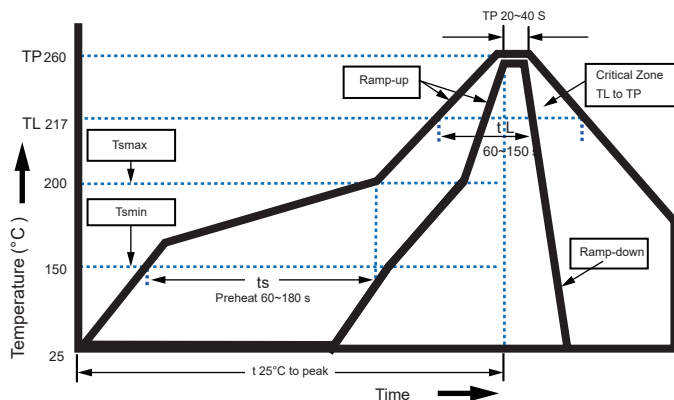
Average Time-Current Curve



Thermal Derating Chart

Model	Maximum ambient operating temperature (T_{mao}) vs. hold current (I_{hold})								
	- 40°C	- 20°C	0°C	25°C	40°C	50°C	60°C	70°C	85°C
ASMD2018-030	0.45	0.40	0.35	0.30	0.25	0.23	0.20	0.18	0.14
ASMD2018-050	0.93	0.80	0.65	0.50	0.42	0.38	0.33	0.30	0.23
ASMD2018-075	1.05	0.95	0.85	0.75	0.60	0.55	0.45	0.40	0.30
ASMD2018-100	1.66	1.47	1.29	1.00	0.91	0.83	0.73	0.64	0.50
ASMD2018-150	2.26	2.00	1.76	1.50	1.24	1.13	1.00	0.87	0.68
ASMD2018-200	2.80	2.50	2.19	2.00	1.84	1.74	1.50	1.34	1.14
ASMD2018-260	3.82	3.46	3.06	2.60	2.24	2.03	1.82	1.60	1.26
ASMD2018-300	4.40	3.96	3.52	3.00	2.65	2.43	2.20	1.96	1.59
ASMD2018-350	5.13	4.62	4.11	3.50	3.09	2.84	2.57	2.29	1.86
ASMD2018-500	7.55	6.70	5.85	5.00	4.20	3.77	3.32	2.92	2.23

Soldering Parameters



- Recommended reflow methods: IR, vapor phase oven, hot air oven, N2 environment for lead-free.
- Recommended maximum paste thickness is 0.25mm. Devices can be cleaned using standard industry methods and solvents.
- Note 1: All temperature refer to topside of the package, measured on the package body surface.
- Note 2: If reflow temperatures exceed the recommended profile, devices may not meet the performance requirements.

Profile Feature

Pb-Free Assembly

Average Ramp-Up Rate: 3°C/second max.
($T_{\text{s max}}$ to T_{p})

Preheat

- Temperature Min ($T_{\text{s min}}$): 150°C
 - Temperature Max ($T_{\text{s max}}$): 200°C
 - Time ($T_{\text{s min}}$ to $T_{\text{s max}}$): 60~180 seconds

Time maintained above:

- Temperature (TL): 217°C
 - Time (TL): 60~150 seconds

Peak Temperature (T_{p}): 260°C

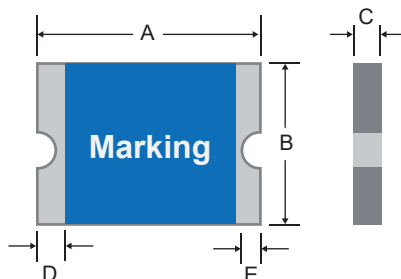
Ramp-Down Rate: 6°C/second max.

Time 25°C to Peak Temperature: 8 minutes max

Storage And Handling:

Storage conditions: 0°C~35°C, 30%~60% R.H.

Devices may not meet specified performance if storage conditions are exceeded.

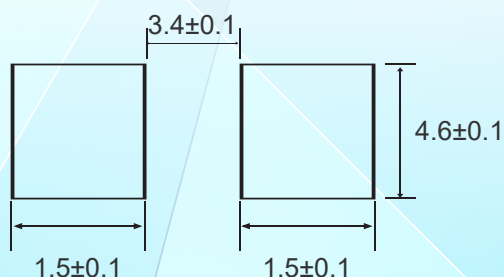
Physical Dimensions(mm.)


Model	A		B		C		D		E
	Min.	Max.	Min.	Max.	Min.	Max.	Min.	Max.	Min.
ASMD2018-030-60V	5.05	5.45	4.05	4.45	0.65	1.15	0.30	1.50	0.25
ASMD2018-050-60V	5.05	5.45	4.05	4.45	0.65	1.15	0.30	1.50	0.25
ASMD2018-075-60V	5.05	5.45	4.05	4.45	0.35	0.85	0.30	1.50	0.25
ASMD2018-100-15V	5.05	5.45	4.05	4.45	0.35	0.85	0.30	1.50	0.25
ASMD2018-100-33V	5.05	5.45	4.05	4.45	0.35	0.85	0.30	1.50	0.25
ASMD2018-150-15V	5.05	5.45	4.05	4.45	0.35	0.85	0.30	1.50	0.25
ASMD2018-150-33V	5.05	5.45	4.05	4.45	0.65	1.15	0.30	1.50	0.25
ASMD2018-200-6V	5.05	5.45	4.05	4.45	0.35	0.85	0.30	1.50	0.25
ASMD2018-200-10V	5.05	5.45	4.05	4.45	0.35	0.85	0.30	1.50	0.25
ASMD2018-200-12V	5.05	5.45	4.05	4.45	0.35	0.85	0.30	1.50	0.25
ASMD2018-200-16V	5.05	5.45	4.05	4.45	0.65	1.15	0.30	1.50	0.25
ASMD2018-200-24V	5.05	5.45	4.05	4.45	0.65	1.15	0.30	1.50	0.25
ASMD2018-260-24V	5.05	5.45	4.05	4.45	0.85	1.35	0.30	1.50	0.25
ASMD2018-300-16V	5.05	5.45	4.05	4.45	0.65	1.15	0.30	1.50	0.25
ASMD2018-350-12V	5.05	5.45	4.05	4.45	0.65	1.15	0.30	1.50	0.25
ASMD2018-500-6V	5.05	5.45	4.05	4.45	0.85	1.35	0.30	1.50	0.25
ASMD2018-500-12V	5.05	5.45	4.05	4.45	0.85	1.35	0.30	1.50	0.25

Termination Pad Characteristics

Terminal Material: Tin-Plated Nickel-Copper (Solder Material: Matte Tin (Sn))

Lead Solderability: Meets EIA specification RS186-9E, ANSI/J-STD-002 Category 3.

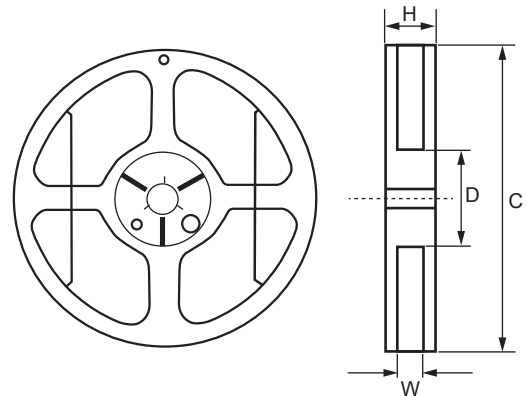
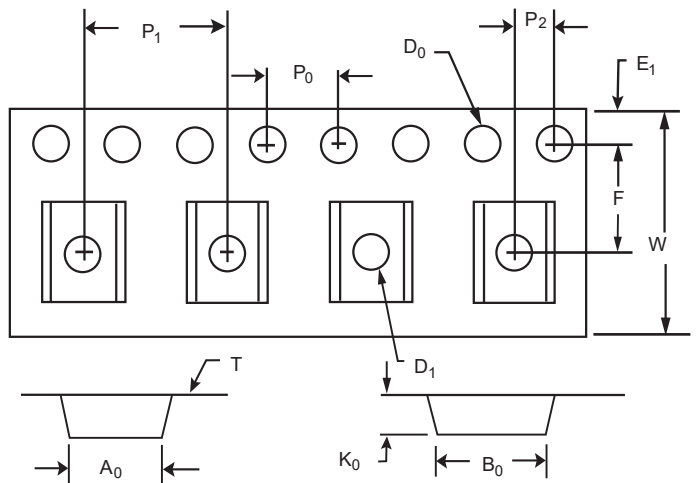
Recommended Pad Layout and Packaging Quantity


Part Number	Quantity
ASMD2018-100/150/200/200-16V	2500 pcs/reel
The others	1500 pcs/reel
Tape & reel packaging per EIA481-1	

Tape And Reel Specifications (mm)

Governing Specifications	EIA 481-1
W	12.0 ± 0.10
F	5.50 ± 0.05
E1	1.75 ± 0.10
D0	1.55 ± 0.05
D1	1.5 Min
P0	4.00 ± 0.10
P1	8.00 ± 0.10
P2	2.00 ± 0.05
A0	4.61 ± 0.10
B0	5.62 ± 0.10
T	0.25 ± 0.05
K0	$0.78/1.35 \pm 0.10$
Leader	390 mm
Trailer	160 mm

REEL DIMENSIONS: EIA-481-1(mm)	
C	$\phi 178 \pm 1.0$
D	$\phi 60.2 \pm 0.5$
W	9.0 ± 1.5
H	11.0 ± 0.5


Part Number System
ASMD 2018 - □□□ - □□

Special Voltage Rating(Optional)

Holding Current Rating

Device Dimensions:
Length/width(Unit:1/100 inch) Size 5045 mm / 2018 inch

Surface Mount Device

Cross Reference

Model	Cross Reference		
	Tyco / PolySwitch®	Littelfuse / POLY-FUSE®	Polytronics / EVERFUSE®
ASMD2018-030	SMD030F-2018	2016L030	SMD2016P030TF
ASMD2018-050	SMDC050F/60	2016L050	SMD2016P050TF
ASMD2018-075	-	2016L075/60	-
ASMD2018-100	SMD100F-2018	2016L100	SMD2016P100TF
ASMD2018-100-33V	-	2016L100/33	SMD2016P100TF/33
ASMD2018-150	SMD150F-2018	2016L150	SMD2016P150TF
ASMD2018-150-33V	-	2016L150/33	-
ASMD2018-200	SMD200F-2018	2016L200	SMD2016P200TF
ASMD2018-260	-	2016L260/24	-
ASMD2018-300	-	2016L300/16	-

“PolySwitch” is a registered trademark of Tyco Electronics.

“POLY-FUSE” is a registered trademark of Littelfuse, Inc.

“EVERFUSE” is a registered trademark of Polytronics Technology Corp.

Application Notice

1. Operation of these PPTC devices beyond the stated maximum ratings could result in damage to the devices and lead to electrical arcing and/or fire;

PPTC 器件在超过规定的最大值额定值运行可能会导致器件损坏以及导致电弧和/或火灾。

2. These PPTC devices are intended to protect against the effects of temporary over-current or over-temperature conditions and shall not be taken for use as switch.

PPTC 的作用是防止临时的过流或过温造成的不良影响，不能当作开关使用。

3. Exposure to lubricants, silicon-based oils, solvents, gels, electrolytes, acids, and other related or similar materials may adversely affect the performance of PPTC devices.

PPTC 接触润滑剂、硅基油、溶剂、凝胶、电解质、酸和其他相关或类似材料可能会对 PPTC 器件的性能有不利影响。

4. Circuits with inductance may generate a voltage above the rated voltage of the PPTC device and should be thoroughly evaluated within the user's application during the PPTC selection and qualification process.

带有电感的电路可能产生高于 PPTC 额定电压的电压，因此客户在选型和认定过程中应进行彻底的评估。

5. Please do not smash, clamp, pull, dent or twist by tool during assembling process, as they may result in the PPTC damage.

在装配过程中，避免有砸、挤、拉、扭等方式外力作用于 PPTC 本体上，因为它们可能导致 PPTC 损坏。

6. Hand-soldering of PPTC devices on boards is generally not recommended. Users shall define and verify this process if needed.

不推荐使用手工焊接的方式焊接 PPTC。如果需要，用户需要定义和验证此过程。

7. Recommended storage conditions should be followed at all times, The MSL classification of PPTC is grade 2a.

必须始终遵守推荐的保存条件要求，PPTC 的 MSL 等级为 2 a 级。